L Number	Hits	Search Text	DB	Time stamp
77	1	("6022804").PN.	USPAT	2003/04/19 17:48
78	2	("4840923" | "4872050").PN.	USPAT	2003/04/19 17:48
79	1	("5656545").PN.	USPAT	2003/04/19 17:50
80	67	((cmp or (chemical near polish$3)) near (plug or plugs)) and oxide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:12
81	54	(((cmp or (chemical near polish$3)) near (plug or plugs)) and oxide) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:26
82	285	((etch or etching) near (plug or plugs)) and oxide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:23
83	169	(((etch or etching) near (plug or plugs)) and oxide) and (cmp or (chemical near polish$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:12
84	124	((((etch or etching) near (plug or plugs)) and oxide) and (cmp or (chemical near polish$3))) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:17
85	426	sin near (insulat$3 or dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:18
86	196	((etch or etching) and (cmp or polish or polishing) near oxide) and (plug or plugs)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:24
87	158	(((etch or etching) and (cmp or polish or polishing) near oxide) and (plug or plugs)) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:27